COPPER PLATE HOLES MINIMUM .025 AVG, .020 MIN.. HOLES MAY NOT BE PLUGGED Special requirement: ENIG, Impedance: Tol: \pm 7%, Press fit hole

Pack with colorless transparent bubble film ,25 PCS/ bag, put desiccant in flank, put humidity indicator card on top side $\frac{1}{2}$

Layer structure

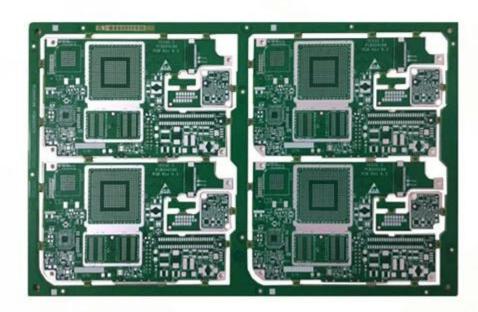












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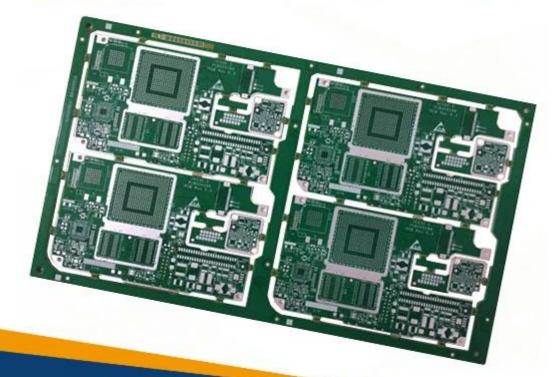












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